Power MOSFET 40 V, 5.6 mΩ, 69 A, Single N–Channel

Features

- Small Footprint (3.3 x 3.3 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Capacitance to Minimize Driver Losses
- NVTFWS005N04C Wettable Flanks Product
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

| Parameter | | | Symbol | Value | Unit |
|-------------------------------------------------------------------------------|-------------------------------------------------------------------|---------------------------------------|-----------------------------------|----------------|------|
| Drain-to-Source Voltag | V _{DSS} | 40 | V | | |
| Gate-to-Source Voltage | | | V _{GS} | ±20 | V |
| Continuous Drain | | $T_{C} = 25^{\circ}C$ | ۱ _D | 69 | А |
| Current R _{θJC} (Notes 1, 2, 3, 4) | Steady | T _C = 100°C | | 39 | |
| Power Dissipation | State | $T_{C} = 25^{\circ}C$ | PD | 50 | W |
| $R_{\theta JC}$ (Notes 1, 2, 3) | | $T_{C} = 100^{\circ}C$ | | 16 | |
| Continuous Drain | Steady State | $T_A = 25^{\circ}C$ | ۱ _D | 17 | А |
| Current R _{θJA} (Notes 1, 3, 4) | | T _A = 100°C | | 12 | |
| Power Dissipation | | $T_A = 25^{\circ}C$ | PD | 3.1 | W |
| $R_{\theta JA}$ (Notes 1, 3) | | T _A = 100°C | | 1.6 | |
| Pulsed Drain Current | T _A = 25 | $T_A = 25^{\circ}C, t_p = 10 \ \mu s$ | | 297 | А |
| Operating Junction and Storage Temperature Range | | | T _J , T _{stg} | –55 to +175 | °C |
| Source Current (Body D | ۱ _S | 42 | А | | |
| Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 4.6 A) | | | E _{AS} | 103 | mJ |
| | Lead Temperature for Soldering Purposes (1/8" from case for 10 s) | | | 260 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS (Note 1)

| Parameter | Symbol | Value | Unit |
|---------------------------------------------|-----------------|-------|------|
| Junction-to-Case - Steady State (Note 3) | $R_{\theta JC}$ | 3.0 | °C/W |
| Junction-to-Ambient - Steady State (Note 3) | $R_{\theta JA}$ | 47.7 | |

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Psi (Ψ) is used as required per JESD51-12 for packages in which substantially less than 100% of the heat flows to single case surface.

3. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

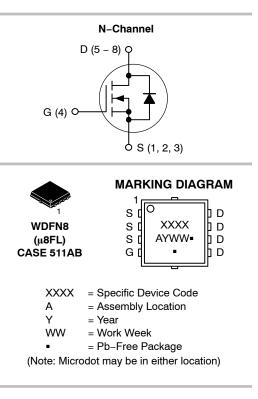
4. Continuous DC current rating. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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| V _{(BR)DSS} | R _{DS(on)} MAX | I _D MAX |
|----------------------|-------------------------|--------------------|
| 40 V | 5.6 m Ω @ 10 V | 69 A |



ORDERING INFORMATION

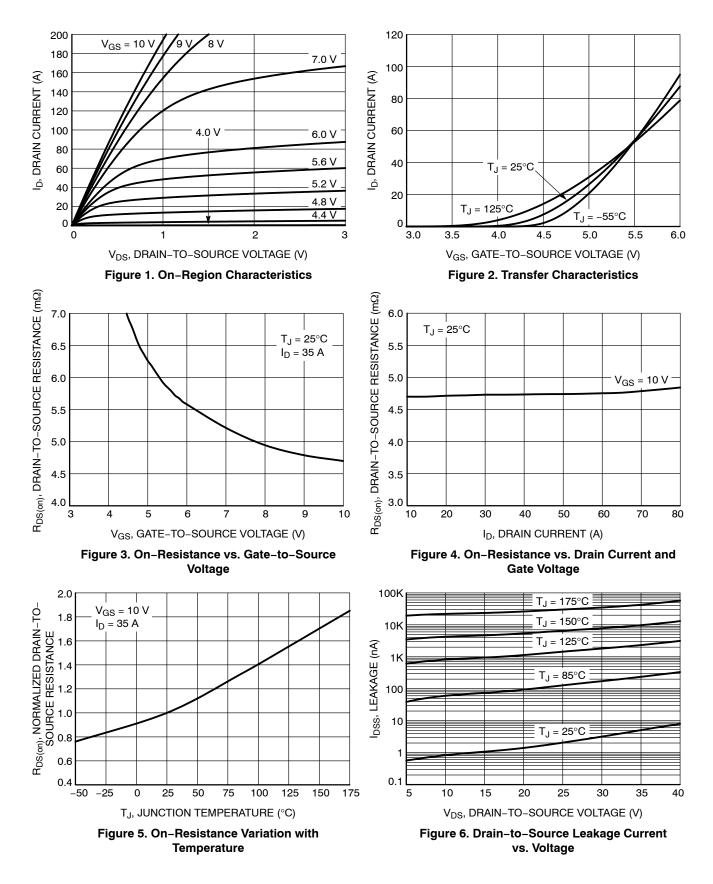
See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

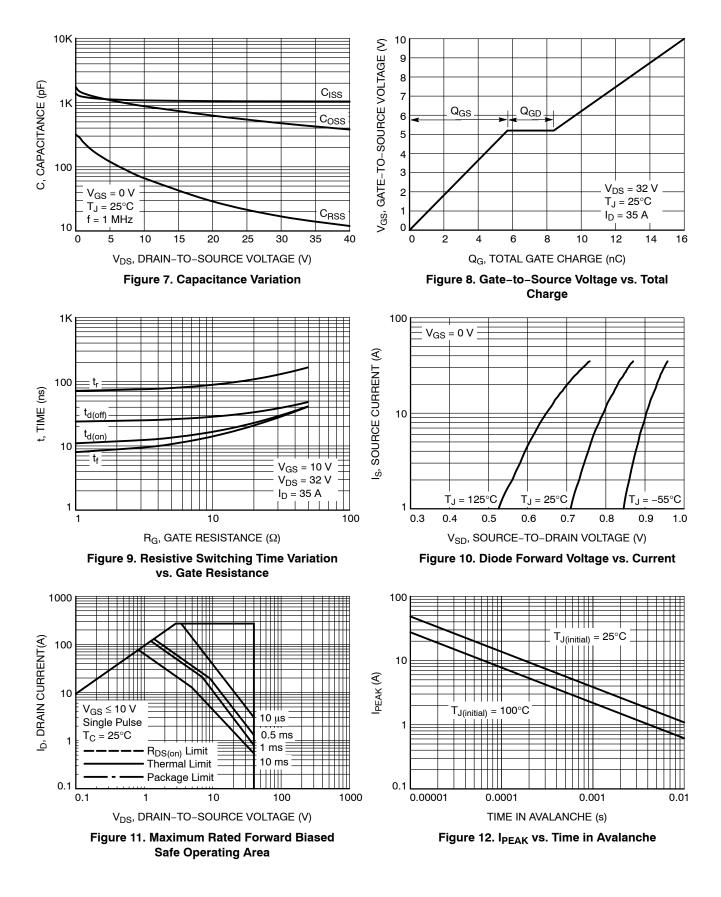
| Parameter | Symbol | Test Condition | | Min | Тур | Max | Unit |
|-----------------------------------|----------------------|-----------------------------------------------------------------------|-------------------------------------|-----|------|-----|------|
| OFF CHARACTERISTICS | • | | | | | | |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | V_{GS} = 0 V, I _D = | V_{GS} = 0 V, I_D = 250 μ A | | - | - | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} = 0 V, | $T_J = 25^{\circ}C$ | - | - | 10 | μΑ |
| | | $V_{DS} = 40 V$ | T _J = 125°C | - | - | 250 | |
| Gate-to-Source Leakage Current | I _{GSS} | $V_{DS} = 0 V, V_{Gi}$ | _S = 20 V | - | - | 100 | nA |
| ON CHARACTERISTICS (Note 5) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | $V_{GS} = V_{DS}, I_D$ | = 40 μA | 2.5 | - | 3.5 | V |
| Drain-to-Source On Resistance | R _{DS(on)} | V _{GS} = 10 V, I _E | ₀ = 35 A | - | 4.7 | 5.6 | mΩ |
| Forward Transconductance | 9 _{FS} | V _{DS} = 15 V, I _E | ₀ = 35 A | - | 53 | - | S |
| CHARGES AND CAPACITANCES | | | | | | | |
| Input Capacitance | C _{iss} | | | - | 1000 | - | pF |
| Output Capacitance | C _{oss} | V _{GS} = 0 V, f = 1 V _{DS} = 25 | 1.0 MHz, 5 V | - | 530 | - | 1 |
| Reverse Transfer Capacitance | C _{rss} | v _{DS} = 23 v | | - | 22 | - | 1 |
| Threshold Gate Charge | Q _{G(TH)} | V _{GS} = 10 V, V _{DS} = 32 V, I _D = 35 A | | - | 3.2 | - | nC |
| Gate-to-Source Charge | Q _{GS} | | | - | 5.7 | - | |
| Gate-to-Drain Charge | Q _{GD} | | | - | 2.7 | - | |
| Total Gate Charge | Q _{G(TOT)} | V_{GS} = 10 V, V_{DS} = 32 V, I_{D} = 35 A | | - | 16 | - | nC |
| SWITCHING CHARACTERISTICS (No | te 6) | | | | | | |
| Turn-On Delay Time | t _{d(on)} | | | - | 11 | - | ns |
| Rise Time | t _r | V _{GS} = 10 V, V _D | s = 32 V. | - | 72 | - | |
| Turn-Off Delay Time | t _{d(off)} | I _D = 35 | | - | 24 | - | |
| Fall Time | t _f | | | - | 8 | - | 1 |
| DRAIN-SOURCE DIODE CHARACTER | RISTICS | | | | | | |
| Forward Diode Voltage | V _{SD} | V _{GS} = 0 V, | $T_J = 25^{\circ}C$ | - | 0.87 | 1.2 | V |
| | | I _S = 35 A | T _J = 125°C | - | 0.75 | - | |
| Reverse Recovery Time | t _{RR} | | | - | 36 | - | ns |
| Charge Time | t _a | V _{GS} = 0 V, dl _S /dt | = 100 A/us. | - | 17 | - | |
| Discharge Time | t _b | I _S = 35 | | - | 18 | - | |
| Reverse Recovery Charge | Q _{RR} | 1 | | _ | 16 | - | nC |

5. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
6. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

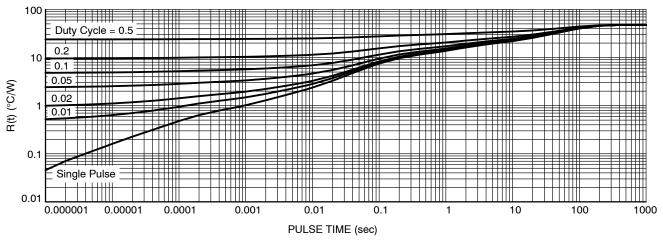


Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

| Device | Marking | Package | Shipping [†] |
|------------------|---------|-------------------------------------|-----------------------|
| NVTFS005N04CTAG | 05NC | WDFN8 (Pb-Free) | 1500 / Tape & Reel |
| NVTFWS005N04CTAG | 05NW | WDFN8 (Pb-Free, Wettable Flanks) | 1500 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

DATE 23 APR 2012





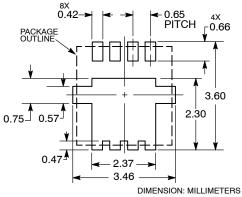
Pb-Free indicator, "G" or microdot " .", may or may not be present.

NOTES: LES: DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. DIMENSION D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS. 1.

2. 3.

| | MILLIMETERS | | | INCHES | | | |
|-----|-------------|----------|------|-----------|-----------|-------|--|
| DIM | MIN | NOM | MAX | MIN | NOM | MAX | |
| Α | 0.70 | 0.75 | 0.80 | 0.028 | 0.030 | 0.031 | |
| A1 | 0.00 | | 0.05 | 0.000 | | 0.002 | |
| b | 0.23 | 0.30 | 0.40 | 0.009 | 0.012 | 0.016 | |
| с | 0.15 | 0.20 | 0.25 | 0.006 | 0.008 | 0.010 | |
| D | | 3.30 BSC | | 0 | 0.130 BSC | | |
| D1 | 2.95 | 3.05 | 3.15 | 0.116 | 0.120 | 0.124 | |
| D2 | 1.98 | 2.11 | 2.24 | 0.078 | 0.083 | 0.088 | |
| E | 3.30 BSC | | | 0.130 BSC | | | |
| E1 | 2.95 | 3.05 | 3.15 | 0.116 | 0.120 | 0.124 | |
| E2 | 1.47 | 1.60 | 1.73 | 0.058 | 0.063 | 0.068 | |
| E3 | 0.23 | 0.30 | 0.40 | 0.009 | 0.012 | 0.016 | |
| е | | 0.65 BSC | | (| 0.026 BSC | | |
| G | 0.30 | 0.41 | 0.51 | 0.012 | 0.016 | 0.020 | |
| к | 0.65 | 0.80 | 0.95 | 0.026 | 0.032 | 0.037 | |
| L | 0.30 | 0.43 | 0.56 | 0.012 | 0.017 | 0.022 | |
| L1 | 0.06 | 0.13 | 0.20 | 0.002 | 0.005 | 0.008 | |
| м | 1.40 | 1.50 | 1.60 | 0.055 | 0.059 | 0.063 | |
| θ | 0 ° | | 12 ° | 0 ° | | 12 ° | |

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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|---------------------------------------------|-----------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|--|--|--|
| DESCRIPTION: WDFN8 3.3X3.3, 0.65P PAGE 1 OF | | | | | | |
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